

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Metalform Asia Thailand	03/17/2009
RECEIVING PARTY DATA	
Name:	Metalform Asia Pte Ltd.
Street Address:	No. 50, Yishun Industrial Park A
City:	Singapore
State/Country:	SINGAPORE
Postal Code:	768725
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13203099
CORRESPONDENCE DATA	
Fax Number:	(312)775-8100
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Email:	mhmpto@mcandrews-ip.com
Correspondent Name:	MCANDREWS HELD & MALLOY, LTD
Address Line 1:	500 WEST MADISON STREET
Address Line 2:	SUITE 3400
Address Line 4:	CHICAGO, ILLINOIS 60661
ATTORNEY DOCKET NUMBER:	24535US01
NAME OF SUBMITTER:	Nabeela R. McMillian
Total Attachments: 2	
source=24535US01_Assignment_Metalform_Asia_Thailand_to_Metalform_Asia#page1.tif	
source=24535US01_Assignment_Metalform_Asia_Thailand_to_Metalform_Asia#page2.tif	

CH \$40.00 13203099

DEED OF ASSIGNMENT

THIS DEED made the 17th day of March two thousand and nine (2009)
BETWEEN,

- (i) **METALFORM ASIA THAILAND** of
70/8-11 Moo 9, Rojana Industrial Park
Tambon Thanu, Ampur U-Thai
Ayutthaya 13210
Thailand

[hereinafter referred to as "the Assignor"]

AND

- (i) **METALFORM ASIA PTE LTD** of
No. 50, Yishun Industrial Park A
Singapore 768725

[hereinafter referred to as "the Assignee"]

WHEREAS the Assignor is the proprietor of the International Patent Application No.
PCT/SG2009/000093 (hereinafter referred to as the "patent application");

AND WHEREAS the Assignor has agreed to assign to the Assignee, and the
Assignee desires to take assignment of all rights, title and interest of the Assignor in
and to the Patent Application and the invention covered thereby,

NOW THIS DEED WITNESSETH

1. In consideration of the sum of Singapore Dollars One Only (SGD 1.00) and other good and valuable consideration paid by the Assignee to the Assignor, the receipt and sufficiency of which the Assignor hereby acknowledges, the Assignor as legal and beneficial owner hereby assigns to the Assignee, its successors, legal representatives and assigns absolutely and free from all incumbrances, the right (including the right to sue for infringement of the Patent Applications occurring before the date of this assignment), title and interest in and to its ownership the Patent Application including all patents that may issue thereof and the inventions covered thereby to the end of the term or terms for which the Patent Application is granted.

2. The Assignor will at the request and expense of the Assignee execute any further documents that the Assignee may reasonably require to enable the Assignee to become registered as the applicant of the Patent Application.

3. The Assignor warrants that the Assignor is the sole applicant of the Patent Application and has full power to enter into this Agreement. The Assignor further warrants that the Patent Application is still subsisting.

4. The Assignor does not warrant or guarantee the validity of the Patent Application or that the invention covered by the Patent Application do not infringe any valid and subsisting patents or other rights not held by the Assignor.

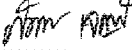
IN WITNESS WHEREOF the Assignor and Assignee executed this Deed the day and year first hereinbefore written.

ASSIGNOR

SIGNED, SEALED and DELIVERED

By **METALFORM ASIA THAILAND**

in the presence of:


.....

(Witness)


.....

ASSIGNEE

SIGNED, SEALED and DELIVERED

By **METALFORM ASIA PTE LTD**

in the presence of:


.....

(Witness)


.....